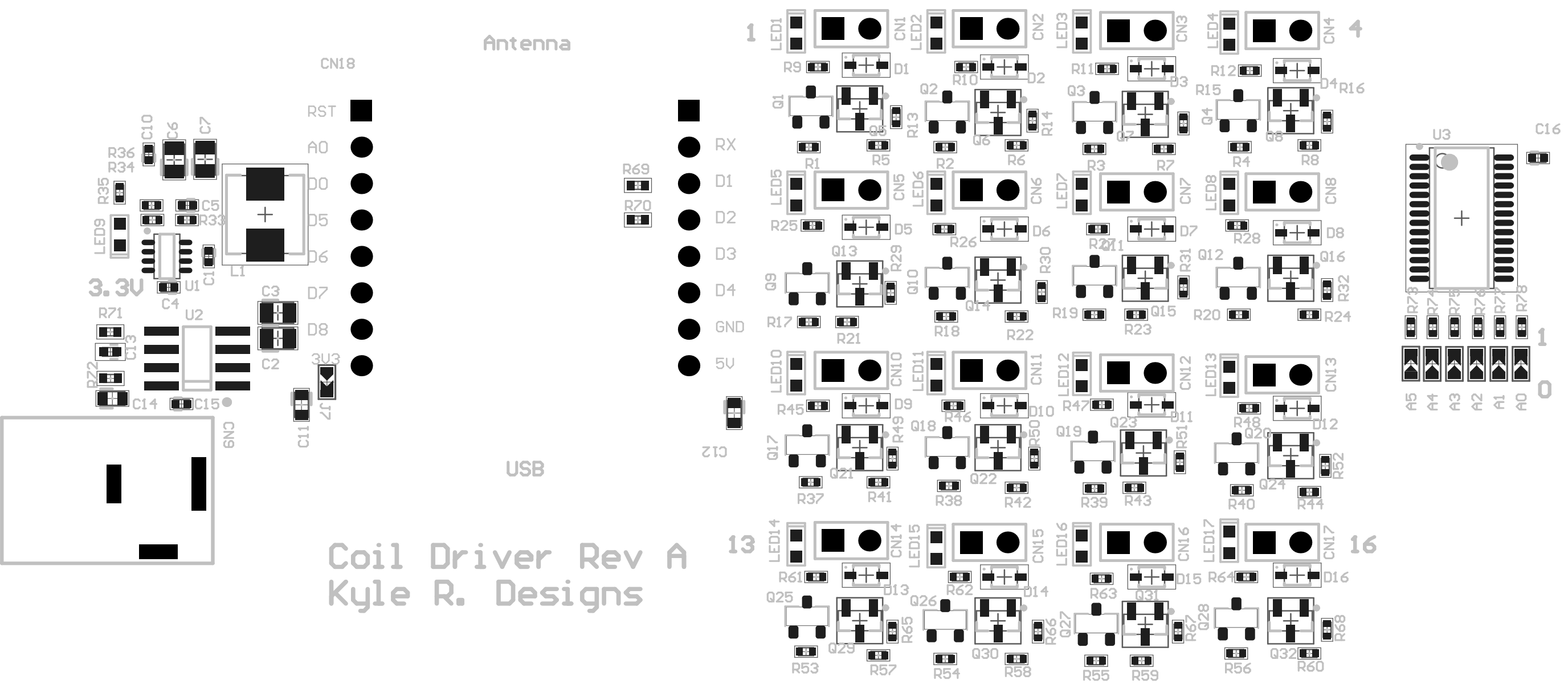


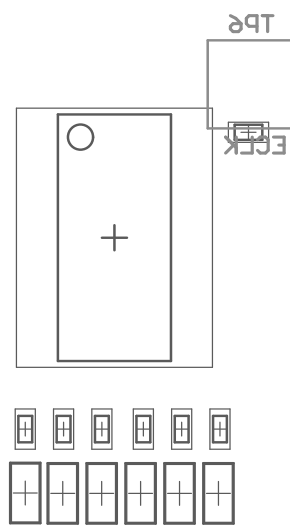
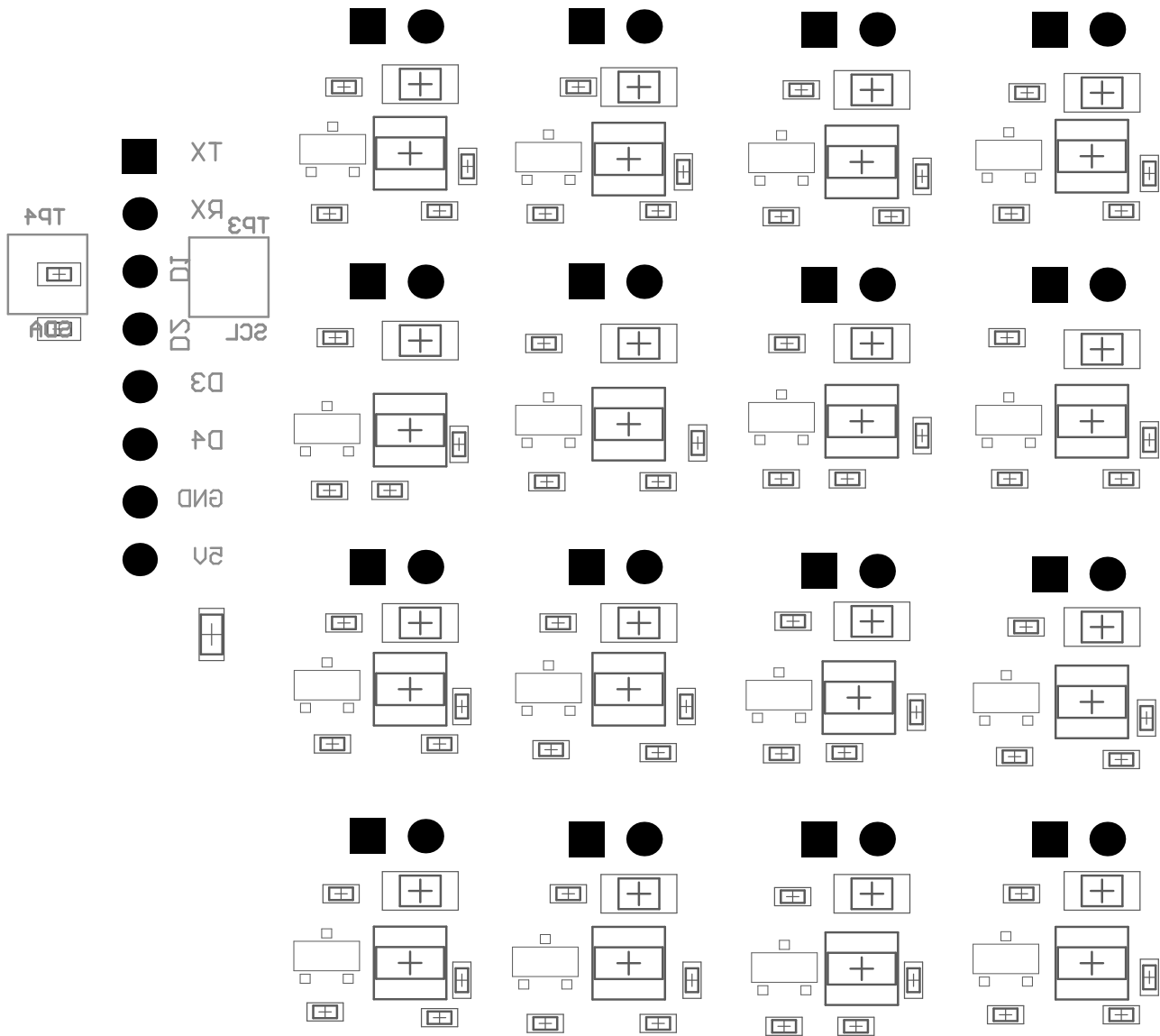
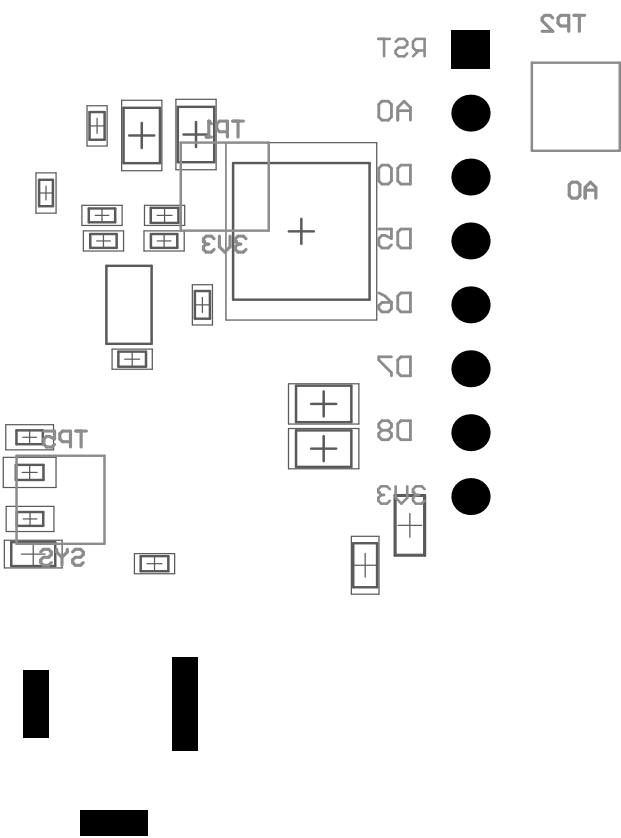
# Fabrication Notes

xxxxx Main Rev A	June 1, 2018
Ref Sch: xxxx_Rev_A	
Workmanship and Quality per IPC-A-600E, IPC-2221, IPC-6012 class 2 Board Thickness: 0.062 inches +/- 10% 2 Layers FR4 See Stackup for copper thickness. No copper fill ENIG finish Solder Mask to be Blue Legend to be White	
No epoxy fill on vias No clean RoHS compliant with certification papers Dimensions in mils.	



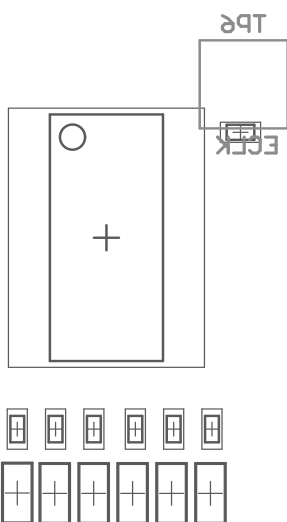
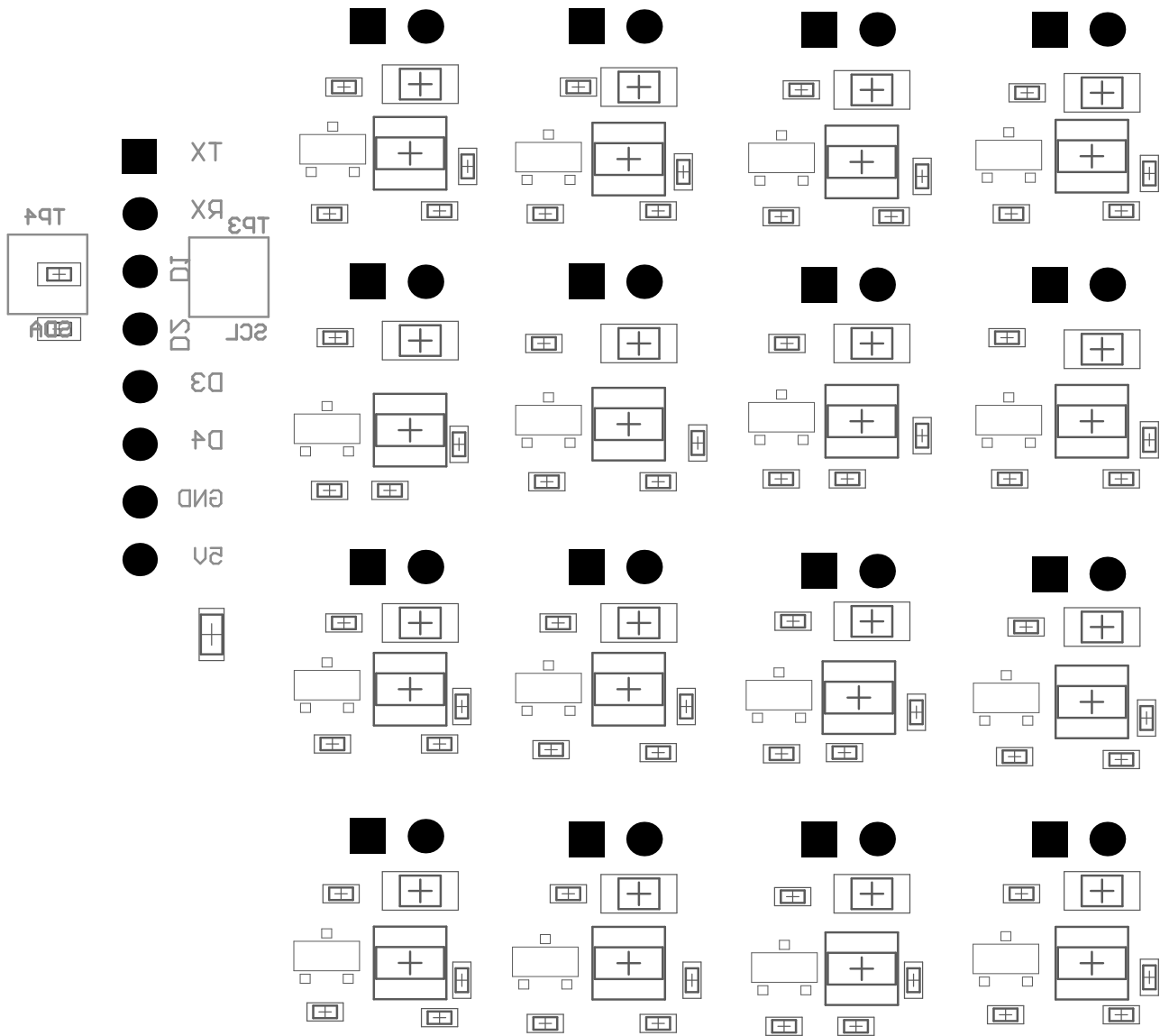
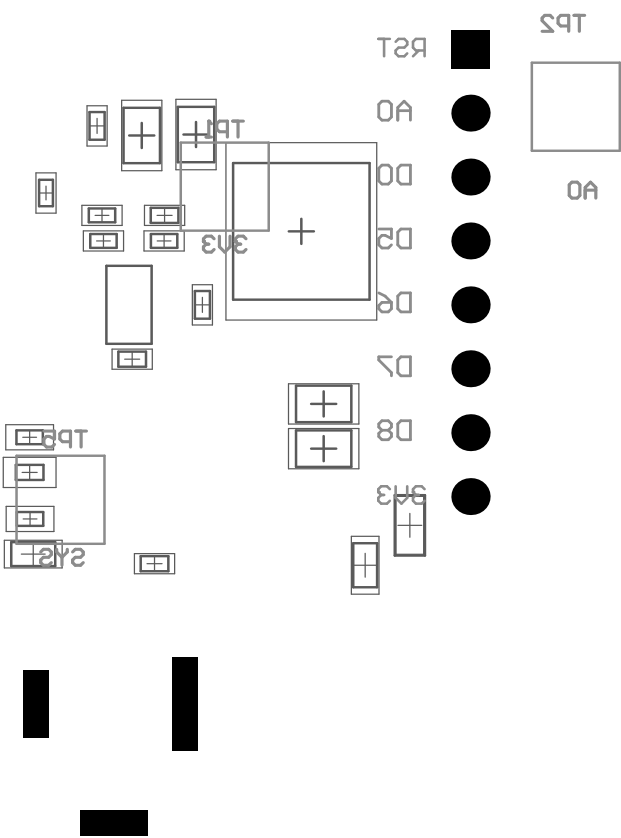
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## Fabrication Notes

xxxxx Main Rev A

June 1, 2018

Ref Sch: xxxx\_Rev\_A

Workmanship and Quality per IPC-A-600E,  
IPC-2221, IPC-6012 class 2

Board Thickness: 0.062 inches +/- 10%

2 Layers FR4

See Stackup for copper thickness.

No copper fill

ENIG finish

## Solder Mask to be Blue

## Legend to be White

## No epoxy fill on vias

No clean

RoHS compliant with certification papers

Dimensions in mils.

